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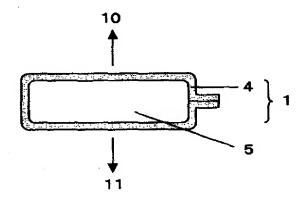
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(54) 【発明の名称】 真空新熱材

(57)【要約】

【課題】 本発明は、真空断熱材の外装体を通しての熱 の移動がなく十分な断熱性能が得られ、且つ、外装体の ガスバリア性が高く、長期に亘って外装体内部の真空状 態が保たれ、断熱性能が維持される真空断熱材を提供す ることにある。

【解決手段】 ガスパリア性を有する積層フィルムから なる外装体内部に断熱コア材を封入し、その外装体内部 を真空排気した真空断熱材において、前記積層フィルム が、支持基材上に形成された有機物膜と無機物膜との積 層膜を含むことを特徴とする真空断熱材を提供する。



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【特許請求の範囲】

【請求項1】 ガスパリア性を有する積層フィルムからな る外装体内部に断熱コア材を封入し、その外装体内部を 真空排気した真空断熱材において、前記積層フィルム が、支持基材上に形成された有機物膜と無機物膜との積 **脳膜を含むことを特徴とする真空断熱材。**

【請求項2】前記有機物膜が、電子線または紫外線重合 性樹脂を、電子線または紫外線によって重合硬化させた ものであることを特徴とする請求項1に記載の真空断熱

【請求項3】前配無機物膜の厚さが、5mm以上500 nm以下であることを特徴とする請求項1または2に記 載の真空断熱材。

【請求項4】ガスパリア性を有する2枚の積層フィルム からなる外装体内部に断熱コア材を封入し、その外装体 内部を真空排気した真空断熱材において、前記積層フィ ルムのうち少なくとも1枚が、支持基材上に形成された 有機物膜と無機物膜との積層膜を含むことを特徴とする 真空断熱材。

【請求項5】前記積層フィルムのうち、高温側に位置す 20 る1枚が、熱反射性の材料を含むことを特徴とする請求 項4のいずれかに記載の真空断熱材。

【発明の詳細な説明】

[0001]

【発明の属する技術分野】本発明は、冷蔵庫や低温コン テナ等に取り付けて、断熱効果を発揮する真空断熱材に 関するものである。

[0002]

【従来の技術】冷蔵庫や低温コンテナ等には、従来から 種々の断熱材が用いられており、特に、断熱性能の優れ 30 た断熱材として、断熱性のコア材を外装体内に封入し、 内部を真空排気した構成の真空断熱材が使用されてい る。この外装体は、外部からのガス(空気)の侵入を防 ぎ、内部を長期間真空状態に保持するために、ガスバリ ア性に優れたものである必要がある。そこで、従来、高 いガスパリア性を持たすために、外装体のガスパリア層 のとして7~15 µm程度の厚さの金属アルミニウム箔 を含む積層フィルムが主として用いられてきた。

[0003]

【発明が解決しようとする課題】しかし、このようなア 40 ルミ箔の場合、ガスバリア性には優れているが、アルミ ニウム自体の熱伝導率が高いため、外装体を通しての熱 伝導〔ヒートブリッジ〕によって、十分な断熱性能が得 られないという問題があった。この問題の解決を目的と して、外装体のガスパリア層に、熱伝導率が比較的小さ いステンレス箔などを用いる方法(特購平8-1593 76号公報〕やアルミニウムの蒸着膜を用いる方法、セ ラミックスやガラスの蒸着膜を用いる方法〔特開平7-113493号公報、特開平8-152258号公報) などが発明されている。

【0004】しかし、ステンレス箱などを用いる方法で は、まだなおステンレスの熱伝導率が高いためにヒート ブリッジの低減が不十分である。また、アルミニウムや セラミックスあるいはガラスの蒸着膜を用いる方法で は、ヒートブリッジの低減は十分であるが、蒸着膜にピ ンホールやクラックが存在するためガスバリア性が不十 分であり、長期間に亘って、外装体の内部を真空状態に 保っておくことが不可能であった。本発明はこのような 事情に鑑みてなされたもので、その目的とするところ は、真空断熱材の外装体を通しての熱の移動がなく十分 な断熱性能が得られ、且つ、外装体のガスバリア性が高 く、長期に亘って外装体内部の真空状態が保たれ、断熱 性能が維持される真空断熱材を提供することである。

[0005]

【発明を解決するための手段】請求項1に記載の発明 は、ガスパリア性を有する積層フィルムからなる外装体 内部に断熱コア材を封入し、その外装体内部を真空排気 した真空断熱材において、前記積層フィルムが、支持基 材上に形成された有機物膜と無機物膜との積層膜を含む ことを特徴とする真空断熱材である。

【0006】請求項2に記載の発明は、前記有機物膜 が、電子輸または紫外線重合性樹脂を、電子線または紫 外線によって重合硬化させたものであることを特徴とす る請求項1に記載の真空断熱材である。

【0007】請求項3に記載の発明は、前記無機物膜の 厚さが、5 nm以上500 nm以下であることを特徴と する請求項1または2に記載の真空断熱材である。

【0008】請求項4に記載の発明は、ガスパリア性を 有する2枚の積層フィルムからなる外装体内部に断熱コ ア材を封入し、その外装体内部を真空排気した真空断熱 材において、前記積層フィルムのうち少なくとも1枚 が、支持基材上に形成された有機物膜と無機物膜との積 層膜を含むことを特徴とする真空断熱材である。

【0009】請求項5に記載の発明は、前記積層フィル ムのうち、高温側に位置する1枚が、熱反射性の材料を 含むことを特徴とする請求項4のいずれかに記載の真空 断熱材である。

[0010]

【発明の実施の形態】以下、本発明の一実施の形態を図 を用いて詳細に説明する。本発明の真空断熱材は、ガス パリア性を有する積層フィルムを含む外装体1の内部に 断熱コア材5が封入され、外装体内部が真空排気されて いるものであって、前記積層フィルム、有機物膜7と無 機物膜8との積層膜を含むことを特徴とするものであ る。本発明の真空断熱材は、ガスパリア性を有する積層 フィルム2、3をからなる外装体からなり、最後に4方 シールして真空断熱材としてもよいし(図1)、1枚の ガスパリア性を有する積層フィルム4をからなる外装体 からなり、最後に3方シールして真空断熱材としてもよ

50 い(図2)。

【0011】本発明の有機物膜と無機物膜との積層膜を 含む積層フィルムは、少なくとも支持基材上に有機物膜 と無機物膜との積層膜を形成したものである。支持基材 としては、ポリエチレンテレフタレート(PET)、ポ リエチレンナフタレート(PEN)、ポリプチレンテレ フタレート (PBT) などのポリエステル、ポリエチレ ン (PE)、ポリプロピレン (PP)、ポリスチレン (PS) などのポリオレフィン、ナイロンー6、ナイロ ン-66などのポリアミド (PA)、ポリイミド、ポリ アクリレート、ポリ塩化ビニル(PVC)、ポリ塩化ビ 10 ニリデン(PVDC)、ポリビニルアルコール(PV A)、エチレンービニルアルコール共重合体(EVO H)、ポリカーボネート(PC)、ポリエーテルスルフ ォン(PES)、ポリメチルメタクリレート(PMM A)などやこれらの共重合体の無延伸あるいは延伸フィ ルムである。これらの支持基材の表面は、有機物膜と無 機物膜との積層膜の形成に先立って、コロナ処理、火炎 処理、低温プラズマ処理、薬品処理等の表面処理が施さ れていても差し支えない。またこれらのプラスチックフ ィルムには、必要に応じて帯電防止剤や紫外線吸収剤、 可塑剤、滑剤などといった添加剤が含まれていても構わ

【0012】本発明における無機物膜としては、金属ア ルミニウム(Al)、酸化アルミニウム(AlOx)、 酸化珪素(SiOx)、酸化マグネシウム(MgO)、 酸化カルシウム (CaO)、酸化チタン (TiO₂)、 酸化ジルコニウム(2r0z)、窒化アルミニウム(A IN)、窒化チタン(TiN)、窒化珪素(Si ₃N₁)、酸窒化アルミニウム(A 1 O x N y)、酸窒化 珪素(SiOxNy)、酸窒化チタン(TiOxN v)、インジウム錫酸化物(ITO)、インジウムセリ ウム酸化物(ICO)などの無機物の単独膜もしくは複 数の無機物の混合物膜や積圧膜が用いられる。このよう な無機物膜は、真空蒸着法、スパッタリング法、化学的 蒸着法(CVD法)などの真空プロセスによって形成さ れる。また、その厚さは無機物膜の種類によって若干異 なるが、5nm以上、500nm以下であることが重要 である。5 n m以下であると支持基材上に設けられた無 機物が島状になって膜状にならない場合があり、500 n m以上の場合には、膜自身の内部応力によって、膜が 割れたり、支持基材から剥がれたりする場合があるため である。また、無機物膜がA1の場合には、ヒートブリ ッジが大きくなって、断熱性能が低下することがあるた め、特に500nm以下であることが重要である。ま た、ガスパリア性能や断熱性能を阻害しない程度であれ ば、このような無機物膜中にその他の成分が含まれてい ても差し支えない。

【0013】本発明における有機物膜は、支持基材表面 の凹凸を平滑にすること、無機物膜のクラックや欠陥の

こと、無機物膜を保護すること、などを目的として設け られるもので、これらの目的に添うものであれば、その 成分や組成、厚さ、形成方法など、いずれも特に限定さ れるものではない。しかし、重合硬化速度の速さや塗工 後のエージングが不要であることなどから紫外線あるい は電子線重合性の樹脂を、紫外線あるいは電子線で硬化 させたものであることが好ましい。

【0014】具体的には、イソアミルアクリレート、ラ ウリルアクリレート、ステアリルアクリレート、ブトキ シエチルアクリレート、エトキシジエチレングリコール アクリレート、メトキシトリエチレングリコールアクリ レート、メトキシポリエチレングリコールアクリレー ト、メトキシジプロピレングリコールアクリレート、フ ェノキシエチルアクリレート、フェノキシポリエチレン グリコールアクリレート、フェノールEO変性アクリレ ート、ノニルフェノール E O変性アクリレート、テトラ ヒドロフルフリルアクリレート、イソボニルアクリレー ト、2ーヒドロキシエチルアクリレート、2ーヒドロキ シプロピルアクリレート、2-ヒドロキシー3-フェノ キシプロピルアクリレート、2-アクリロイロキシエチ ルコハク酸、2-アクリロイロキシエチルフタル酸、2 ーアクリロイロキシエチルー2ーヒドロキシエチルフタ ル酸、2-エチルヘキシルカルビトールアクリレート、 N-ビニル-2-ピロリドンなどの単官能アクリレー ト、メチルメタクリレート、エチルメタクリレート、n ープチルメタクリレート、イソプチルメタクリレート、 2-エチルヘキシルメタクリレート、イソデシルメタク リレート、nーラウリルメタクリレート、アルキルメタ クリレート、トリデシルメタクリレート、nーステアリ 30 ルメタクリレート、メトキシエチレングリコールメタク リレート、メトキシボリエチレングリコールメタクリレ ート、シクロヘキシルメタクリレート、テトラヒドロフ ルフリルメタクリレート、ベンジルメタクリレート、フ ェノキシエチルメタクリレート、イソボニルメタクリレ ート、2ーヒドロキシエチルメタクリレート、2ーヒド ロキシプロピルメタクリレート、2ーヒドロキシブチル メタクリレート、ジメチルアミノエチルメタクリレー ト、ジエチルアミノエチルメタクリレート、メタクリル 酸、2-メタクリロイロキシエチルコハク酸、2-メタ クリロイロキシエチルヘキサヒドロフタル酸、2-メタ クリロイロキシエチル-2-ヒドロキシプロピルフタレ ート、グリシジルメタクリレートなどの単官能メタクリ レート、トリエチレングリコールジアクリレート、ポリ エチレングリコールジアクリレート、ネオペンチルグリ コールジアクリレート、1.6-ヘキサンジオールジア クリレート、1.9-ノナンジオールジアクリレート、 ジメチロールトリシクロデカンジアクリレート、エチレ ングリコールジメタクリレート、ジエチレングリコール ジメタクリレート、1. 4ープタンジオールジメタクリ 伝播を遮断すること、無機物膜中の内部応力を緩和する 50 レート、1.6-ヘキサンジオールジメタクリレート、

1. 9-ノナンジオールジメタクリレート、グリセリン ジメタクリレート、2ーヒドロキシー3ーアクリロイロ キシプロピルメタクリレートなどの2官能のアクリレー トやメタクリレート、トリメチロールプロパントリアク リレート、ペンタエリスリトールトリアクリレート、ペ ンタエリスリトールテトラアクリレート、ジペンタエリ スリトールヘキサアクリレート、トリメチロールプロパ ントリメタクリレート、ペンタエリスリトールトリアク リレートヘキサメチレンジイソシアネート、ペンタエリ スリトールトリアクリレートトリレンジイソシアネー ト、ペンタエリスリトールトリアクリレートイソホロン ジイソシアネート、ジペンタエリスリトールヘキサアク リレート、ジペンタエリスリトールヘキサアクリレート カプロラクトン付加物、ソルビトールヘキサアクリレー トエチレンオキサイド (EO) 付加物などの3官能以上 のアクリレートやメタクリレート、などが挙げられるが これらに限定されるものではない。

【0015】また、これらのアクリレートやメタクリレートを単独で用いても良いし、2つ以上を混ぜ合わせて用いても良い。特に、単官能のアクリレートやメタクリレートの場合は、2官能以上のアクリレートやメタクリレートと混合して用いられる。また、その他の紫外線硬化性や電子線硬化性を持たない有機化合物と混ぜ合わせて用いても良い。

【0016】このような有機物膜は、紫外線や電子線を照射することによって重合硬化するため、成膜速度が速い、エージングなどの後処理を必要としない、真空中での成膜も可能であり、不純物の混入が避けられる上に、無機物を成膜するための真空プロセスとのインライン化が可能である、などの優れた特徴を持っているものである。 また、その厚さは有機物の種類やコーティング方法、硬化手段などによって異なるが、概ね0.2~5.0 μm程度が好適である。0.2 μmよりも薄いと有機物膜が連続膜にならない場合があるためであり、5.0 μmよりも厚いと、有機物膜の硬化収縮によって無機物膜にストレスがかかり、パリア性の低下が見られる場合があるためである。

【0017】このような有機物膜の成膜方法としては、所望の有機物やその混合物を溶剤に溶かしてグラビアコーティングなどの方法でコーティングした後、オーブン 40 などで溶剤を揮発させ、次いで紫外線や電子線を照射して重合硬化させるのも一つの方法である。また、所望の有機物やその混合物を真空中で蒸発させ、冷却した基材上に液体膜として凝縮させた後、紫外線や電子線を照射して重合硬化させてもよく、この場合、真空中での蒸発方法としては、フラッシュ蒸発法が、所望の組成の有機物膜が容易に、しかも高速で得られることから、最も適した方法であると言える。

【0018】また、前記有機物膜と無機物膜との積層順 本発明の積層フィルム4を得た。次いで、この積層フィ 序や層数には特に制限はなく、複数の有機物膜や無機物 50 ルムのシーラント層9同士を向かい合わせ、周辺をヒー

膜が同一のものであっても良いし、別のものであってもよい。また、有機物膜と無機物膜の他にさらに他の機能層を積層して積層フィルムとしてもよい。例えば、突き刺し強度を向上させるためにナイロン等を積層することができる。

【0019】本発明では、前記外装体構成するガスバリア性を有する積層フィルムが2枚であってもよく、その場合、高温側の積層フィルムが、熱反射性の材料を含んでいることが好ましく、低温側の積層フィルムが、前記10 有機物膜と無機物膜との積層膜を含んでいることが好ましい。熱反射材料としては、例えば金属箔などが挙げられる。このようにすれば高温側からの熱を反射し、低温側への熱の伝導を低減することができる。

【0020】さらに積層フィルム2、3、4は、最外層にポリエチレン、ポリプロピレン、エチレン共重合体等ヒートシール性を有する樹脂からなるシーラント層9が積層されてなるものである。このようなシーラント層は、フィルム化した材料を接着剤(図示せず)を介してラミネートしたり、溶融した樹脂を直接押出すことによって積層される。

【0.021】また、本発明の真空断熱材として用いるためには前記積層フィルム2、3、4のガスパリア性として、酸素透過度、水蒸気透過度がそれぞれ0.5(cm $^3/\text{m}^2 \cdot \text{day}$)、0.1(g $/\text{m}^4 \cdot \text{day}$)以下であると好ましく、0.1(c $\text{m}^3/\text{m}^2 \cdot \text{day}$)、0.05(g $/\text{m}^4 \cdot \text{day}$)以下であるとさらに好ましい。

【0022】このような構成からなる積層体のヒートシール性樹脂層を内面として、断熱性コア材4を充填し真空包装することによって本発明の真空断熱材を得ることが出来る。この断熱性コア材料は、シリカやパーライト、ケイ酸カルシウム等の粉末を一定の形状に成形した成形体等が使用される。

[0023]

【実施例】次に、本発明の真空断熱材を具体的な一実施 例を挙げて、さらに詳しく説明する。

【0024】<実施例1>厚さ12μmのPETフィルム〔ルミラーP60 東レ製〕を支持体5とし、その片面に乾燥後の厚さが約1μmになるようにアクリレートモノマー〔トリエチレングリコールジアクリレート〕(以下Ac1)をコーティングし、加速電圧120kV、照射線量10Mradの電子線を照射して硬化させることによって有機物膜7を形成した。続いてこの有機物膜7上に電子線加熱式巻取り蒸着装置を用いて厚さ約40nmの酸化珪素(以下SiOx)を成膜し無機物膜8とした後、無機物膜8上にポリエステルウレタン系接着剤(図示せず)を介して厚さ60μmの低密度ポリエチレンフィルムをラミネートしてシーラント層9とし、本発明の機層フィルム4を得た。次いで、この積層フィルムのシーラント層9同士を向かい合わせ、周辺をヒー

トシールし、断熱コア材5として粉末シリカの成形体を 真空密封し、図1に示す真空断熱材を得た。この真空断 熱材の外装体のガスパリア性〔酸素透過速度、水蒸気透 過速度〕およびこの真空断熱材中央部で測定した熱伝導 率を表1に示した。

【0025】<実施例2>有機物膜、無機物膜を実施例1と同様の厚さ、方法で支持体例から順にAc1/SiOx/Ac1のように設けた以外は、実施例1と同様の方法で、本発明の積層フィルム4を得た。この積層フィルムのシーラント層同士を向かい合わせ、周辺をヒートシールし、粉末シリカの成形体を真空密封して得た真空断熱材のガスパリア性と熱伝導率を実施例1と同様にして測定した。その測定結果を表1に示した。

【0026】<実施例3>厚さ12μmのPETフィル ム [ルミラーP60 東レ製] を支持体5とし、その片 面に乾燥後の厚さが約1μmになるように5重量%の光 重合開始剤〔イルガキュア184 チバ・スペシャルテ ィ・ケミカルズ製〕を含むアクリレートモノマー〔トリ プロピレングリコールジアクリレート〕 (以下A c 2) をコーティングし、120m J/c m²の紫外線を照射 して硬化させることによって有機物膜7を形成した。続 いてこの有機物膜7上に、無機物膜8として電子線加熱 式巻取り蒸着装置を用いて厚さ約40mmの金属アルミ ニウム (以下A1) を成膜した後、金属アルミニウム膜 上にポリエステルウレタン系接着剤(図示せず)を介し て厚さ60μmの低密度ポリエチレンフィルムをラミネ ートしてシーラント層9とし、本発明の積層フィルム4 を得た。この積層フィルムのシーラント層同士を向かい 合わせ、周辺をヒートシールし、粉末シリカの成形体を 30 真空密封して得た真空断熱材のガスパリア性と熱伝導率 を実施例1と同様にして測定した。その測定結果を表1 に示した。

3と同様の厚さ、方法で支持体側から順にAc2/Al/Ac2のように設けた以外は、実施例3と同様の方法で、本発明の積層フィルム4を得た。この積層フィルムのシーラント層同士を向かい合わせ、周辺をヒートシールし、粉末シリカの成形体を真空密封して得た真空断熱材のガスパリア性と熱伝導率を実施例1と同様にして測定した。その測定結果を表1に示した。【0028】<実施例5>厚さ12μmのPETフィルム〔ルミラーP60 東レ製〕を支持体5とし、その片面に乾燥後の厚さが約1μmになるようにアクリレートモノマー〔ペンタエリスリトールトリアクリレート・キナメチレンジイソシアネート〕(以下Ac3)をコーティングし、加速電圧120kV、照射線量10Mradの電子線を照射して硬化させることによって有機物膜7を形成した。続いてこの有機物膜7上に、無機物膜8として直接マグネトロン式染物的スパッタロングは要を用

【0027】<実施例4>有機物膜、無機物膜を実施例

いて厚さ約50nmのインジウムセリウム酸化物(以下 ICO)を成膜した後、この酸化物膜上にポリエステルウレタン系接着剤(図示せず)を介して厚さ60μmの低密度ポリエチレンフィルムをラミネートしてシーラント層9とし、本発明の積層フィルム4を得た。この積層フィルムのシーラント層同士を向かい合わせ、周辺をヒートシールし、粉末シリカの成形体を真空密封して得た真空断熱材のガスバリア性と熱伝導率を実施例1と同様にして測定した。その測定結果を表1に示した。

【0029】<実施例6>有機物膜、無機物膜を実施例5と同様の厚さ、方法で支持体側から順にAc3/ICO/

【0030】<実施例7>厚さ12μmのPETフィル ム〔ルミラーP60 東レ製〕を支持体とし、その片面 に、実施例3と同様の方法で、厚さ約40 nmの金属ア ルミニウム(Al)の蒸着層を設け、その上にポリエス テルウレタン系接着剤(図示せず)を介して厚さ60μ mの低密度ポリエチレンフィルムをラミネートしてシー ラント層とし高温側の積層フィルム2を得た。有機物 膜、無機物膜を実施例1と同様の厚さ、方法で支持体側 から順にAc1/SiOx/Ac1/SiOx/Ac1 のように設けた以外は、実施例1と同様の方法で、本発 明の低温側の積層フィルム3を得た次いで、この積層フ ィルム2、3のシーラント層9同士を向かい合わせ、周 辺をヒートシールし、断熱コア材5として粉末シリカの 成形体を真空密封し、図2に示す真空断熱材を得た。こ の真空断熱材の外装体のガスバリア性〔酸素透過速度、 水蒸気透過速度)およびこの真空断熱材中央部で測定し た熱伝導率を表1に示した。

【0031】<比較例1>厚さ12μmのPETフィルム〔ルミラーP60 東レ製〕を支持体とし、その片面に、実施例1と同様の方法で、厚さ約40nmの酸化珪素層(SiOx)を設け、その上にポリエステルウレタン系接着剤(図示せず)を介して厚さ60μmの低密度ポリエチレンフィルムをラミネートしてシーラント層とし、積層体を得た。この積層体のシーラント層同士を向かい合わせ、周辺をヒートシールし、粉末シリカの成形体を真空密封して得た真空断熱材のガスバリア性と熱伝導率を実施例1と同様にして測定した。その測定結果を表1に示した。

イングし、加速電圧120kV、照射線量10Mrad 【0032】<比較例2>厚さ12μmのPETフィルの電子線を照射して硬化させることによって有機物膜7 ム {ルミラーP60 東レ製〕を支持体とし、その片面を形成した。続いてこの有機物膜7上に、無機物膜8と に、実施例3と同様の方法で、厚さ約40nmの金属アして直流マグネトロン式巻取りスパッタリング装置を用 50 ルミニウム(A1)の蒸着層を設け、その上にポリエス

テルウレタン系接着剤(図示せず)を介して厚さ60μ mの低密度ポリエチレンフィルムをラミネートしてシー ラント層とし積層体を得た。この積層体のシーラント層 同士を向かい合わせ、周辺をヒートシールし、粉末シリ カの成形体を真空密封して得た真空断熱材のガスパリア 性と熱伝導率を実施例1と同様にして測定した。その測 定結果を表1に示した。

【0033】<比較例3>厚さ12μmのPETフィルム (ルミラーP60 東レ製)を支持体とし、その片面に、実施例5と同様の方法で、約50nmのインジウム 10セリウム酸化物層 (ICO)を設け、その上にポリエステルウレタン系接着剤 (図示せず)を介して厚さ60μmの低密度ポリエチレンフィルムをラミネートしてシーラント層とし、積層体を得た。この積層体のシーラント層同士を向かい合わせ、周辺をヒートシールし、粉末シリカの成形体を真空密封して得た真空断熱材のガスバリア性と熱伝導率を実施例1と同様にして測定した。その測定結果を表1に示した。

【0034】<比較例4>厚さ12μmのPETフィルム (ルミラーP60 東レ製)を支持体とし、その片面 20に、乾燥後の厚さが約1μmになるようにアクリレート モノマー (トリエチレングリコールジアクリレート)

(Ac1)をコーティングし、加速電圧120kV、照射線量10Mradの電子線を照射して硬化させることによってポリマー層を形成した。そのアクリレート層上にポリエステルウレタン系接着剤(図示せず)を介して厚さ60μmの低密度ポリエチレンフィルムをラミネートしてシーラント層とし、積層体を得た。この積層体のシーラント層同士を向かい合わせ、周辺をヒートシールし、粉末シリカの成形体を真空密封して得た真空断熱材のガスパリア性と熱伝導率を実施例1と同様にして測定した。その測定結果を表1に示した。

【0035】<比較例5>厚さ12μmのPETフィルム(ルミラーP60 東レ製)を支持体とし、その片面に、乾燥後の厚さが約1μmになるように5重量%の光重合開始剤〔イルガキュア184 チバ・スペシャルティ・ケミカルズ製〕を含むアクリレートモノマー〔トリプロピレングリコールジアクリレート〕(Αc2)をコ*

* ーティングし、120mJ/cm²の紫外線を照射して 硬化させることによってポリマー層を形成した。続いて このアクリレート層上にポリエステルウレタン系接着剤 (図示せず)を介して厚さ60μmの低密度ポリエチレ ンフィルムをラミネートしてシーラント層とし、積層体 を得た。この積層体のシーラント層同士を向かい合わ せ、周辺をヒートシールし、粉末シリカの成形体を真空 密封して得た真空断熱材のガスバリア性と熱伝導率を実 施例1と同様にして測定した。その測定結果を表1に示 した。

【0036】<比較例6>厚さ12μmのPETフィルム〔ルミラーP60 東レ製〕を支持体とし、その片面に、乾燥後の厚さが約1μmになるようにアクリレートモノマー〔ペンタエリスリトールトリアクリレートへキサメチレンジイソシアネート〕(Ac3)をコーティングし、加速電圧120kV、照射線量10Mradの電子線を照射して硬化させることによってポリマー層を形成した。続いてこのアクリレート層上にポリエステルウレタン系接着剤(図示せず)を介して厚さ60μmの低密度ポリエチレンフィルムをラミネートしてシーラント層とし、積層体を得た。この積層体のシーラント層同士を向かい合わせ、周辺をヒートシールし、粉末シリカの成形体を真空密封して得た真空断熱材のガスパリア性と熱伝導率を実施例1と同様にして測定した。その測定結果を表1に示した。

【0037】<比較例7>厚さ12μmのPETフィルム〔ルミラーP60 東レ製〕を支持体とし、その片面に、ポリエステルウレタン系接着剤(図示せず)を介して厚さ7μmの金属アルミニウム箔をラミネートし、続いてこの金属アルミニウム箔上に、同じ接着剤を用いて厚さ60μmの低密度ポリエチレンフィルムをラミネートしてシーラント層とし、積層体を得た。この積層体のシーラント層同士を向かい合わせ、周辺をヒートシールし、粉末シリカの成形体を真空密封して得た真空断熱材のガスパリア性と熱伝導率を実施例1と同様にして測定した。その測定結果を表1に示した。

[0038]

【表1】

	分等休中の発展フィルムの	ガスノリア在			
	有機物脈、整備物膜の影構成	(cm²/m²·dan)	水重复 (g/m·ény)	(ML/m·K)	
英基門	Ac1/SiOx	0.5	0.07	0.005	
主放制2	Ac 1/8/0x/Ac 1/8/0x/Ac 1	6.03	0.02	0.095	
变质例3	Ao 2/Ai	6.05	9.05	0.008	
実施製4	Ac 2/AL/Ac 2/AL/Ac 2	5001	<u>≤4.61</u>	0.094	
美国 第8	Ac 3/100	≦ 0.01	≦4.6 1	0.096	
完整信息	Ac 3/100/Ac 3/100/Ac 3	≤9.01	≤0.01	0.005	
突集例7	高電機:Ai 係運搬:Ac 1/8i0x/Ac 1/8i0x/Ac 1	0.5	0.6	0.004	
注意[1]	SIOx	2.5	2	0.070	
建聚制2	Al	O.S	9.8	0.050	
比號何3	100	2	2	0.050	
比较的	Ac 1	140	52	0.000	
止號第5	Ac 2	140	52	0.000	
E MENO	Ac S	149	82	8000	
E 17	ANS.	≤0. 1	30.00	0.010	

積層膜を含むガスパリア性を有する積層フィルムを用い ることにより、真空断熱材の内部を長期間に亘って高い 真空度に保つために不可欠な高いガスバリア性を有する 外装体が得られ、またヒートブリッジによる熱伝導が無 く、高い断熱性能を有する真空断熱材が得られた。ま た、比較例1~3および比較例4~6に示した結果は、 それぞれ無機物膜および有機物膜のみを積層フィルムと して用いた場合のものであるが、これらの外装体では実 施例の場合ほどの高いガスバリア性が得られなかった。 特に比較例4~6の場合では、有機物膜がガスバリア性 10 の向上にほとんど寄与していないため、真空断熱材内部 の真空度が始めから低く、他と比較して初期の熱伝導率 も髙かった。また、比較例7に示した結果は、金属アル ミニウム箔をガスバリア性として用いた場合のものであ るが、この外装体では実施例のものと比較しても十分な ガスバリア性が得られたが、この外装体を用いた真空断 熱材では、ヒートブリッジによる熱伝導によって、高い 断熱性能が得られなかった。

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[0040]

【発明の効果】以上述べたように、本発明によれば、ガスパリア性を有する積層フィルムからなる外装体内に断熱コア材が封入され、その外装体内部が真空排気された真空断熱材において、前記積層フィルムが、支持基材上に形成された有機物膜と無機物膜との積層膜を含むこと*

*によって、真空断熱材の外装体を通しての熱の移動がなく十分な断熱性能が得られ、且つ、外装体のガスパリア性が高く、長期に亘って外装体内部の真空状態が保たれ、断熱性能が維持される真空断熱材を提供することが出来る。

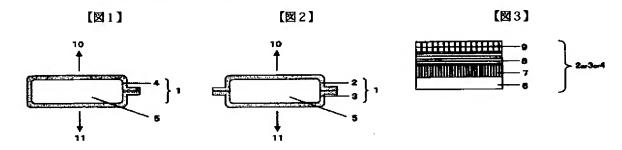
[0041]

【図面の簡単な説明】

- 【図1】本発明の真空断熱材を示す断面図である。
- 【図2】本発明の真空断熱材を示す断面図である。
- 【図3】本発明の真空断熱材の外装体を構成する積層フィルムの一例を示す断面図である。

【符号の説明】

- 1 外装体
- 2 高温側の積層フィルム
- 3 低温側の積層フィルム
- 4 積層フィルム
- 5 断熱コア材
- 6 支持体
- 7 有機物膜
- 8 無機物膜
- 9 シーラント層
- 10 高温度
- 11 低温倒



フロントページの続き

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CLAIMS

[Claim(s)]

[Claim 1] Vacuum insulation material characterized by said laminated film containing the cascade screen of the organic substance film and inorganic substance film which were formed on the support base material in the vacuum insulation material which enclosed heat insulation core material with the interior of the sheathing object which consists of a laminated film which has gas barrier property, and carried out evacuation of the interior of a sheathing object.

[Claim 2] Vacuum insulation material according to claim 1 to which said organic substance film is

[Claim 2] Vacuum insulation material according to claim 1 to which said organic substance film is characterized by carrying out polymerization hardening of an electron ray or the ultraviolet-rays polymerization nature resin by the electron ray or ultraviolet rays.

[Claim 3] Vacuum insulation material according to claim 1 or 2 to which thickness of said inorganic substance film is characterized by 5nm or more being 500nm or less.

[Claim 4] Vacuum insulation material characterized by at least one in said laminated film containing the cascade screen of the organic substance film and inorganic substance film which were formed on the support base material in the vacuum insulation material which enclosed heat insulation core material with the interior of the sheathing object which consists of a laminated film of two sheets which has gas barrier property, and carried out evacuation of the interior of a sheathing object.

[Claim 5] Vacuum insulation material given in either of claims 4 to which one sheet located in an elevated—temperature side among said laminated films is characterized by including the ingredient of thermal reflection.

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DETAILED DESCRIPTION

[Detailed Description of the Invention]
[0001]

[Field of the Invention] This invention is attached in a refrigerator, a low-temperature container, etc., and relates to the vacuum insulation material which demonstrates adiabatic efficiency.

[Description of the Prior Art] Various heat insulators are used from the former, as a heat insulator which was excellent in heat insulation property especially, adiathermic core material is enclosed with the sheathing inside of the body, and the vacuum insulation material of a configuration of having carried out evacuation of the interior is used for the refrigerator or the low-temperature container. This sheathing object needs to be excellent in gas barrier property, in order to prevent invasion of the gas (air) from the outside and to hold the interior to a vacua for a long period of time. Then, in order to give high gas barrier property conventionally, the laminated film which contains metal aluminium foil with a thickness of about 7–15 micrometers as that of the gas barrier layer of a sheathing object has mainly been used.

[0003]

[0002]

[Problem(s) to be Solved by the Invention] However, in the case of such aluminum foil, it excelled in gas barrier property, but since the heat conductivity of aluminum itself was high, there was a problem that sufficient heat insulation property was not obtained by heat conduction [a heat bridge] which lets a sheathing object pass. The approach [JP,8-159376,A] of using a stainless steel foil with comparatively small thermal conductivity etc. for the gas barrier layer of a sheathing object for the purpose of solution of this problem, the approach using the vacuum evaporationo film of aluminum, the ceramics, the approach [JP,7-113493,A and JP,8-152258,A] using the vacuum evaporationo film of glass, etc. are invented.

[0004] However, since the still in addition stainless heat conductivity is high, the approach using a stainless steel foil etc. of reduction of a heat bridge is inadequate. Moreover, although the approach using aluminum, the ceramics, or the vacuum evaporationo film of glass could be enough for reduction of a heat bridge, since a pinhole and a crack existed in the vacuum evaporationo film, gas barrier property was inadequate, and it was impossible to have continued at a long period of time and to have maintained the interior of a sheathing object at a vacua. It is offering the vacuum insulation material by which the gas barrier property of a sheathing object is [material] high, it continues at a long period of time, the vacua inside a sheathing object is maintained [this invention was made in view of such a situation, the place made into the purpose does not have migration of the heat which lets the sheathing object of vacuum insulation material pass, sufficient heat insulation property is obtained, and], and heat insulation property's is maintained.

[0005]

[The means for solving invention] In the vacuum insulation material which invention according to claim 1 enclosed heat insulation core material with the interior of the sheathing object which consists of a laminated film which has gas barrier property, and carried out evacuation of the interior of a sheathing object, it is the vacuum insulation material to which said laminated film is characterized by including the cascade screen of the organic substance film and inorganic substance film which were formed on the support base material.

[0006] It is the vacuum insulation material according to claim 1 to which invention according to claim 2 is characterized by said organic substance film carrying out polymerization hardening of an electron ray or the ultraviolet-rays polymerization nature resin by the electron ray or ultraviolet rays.

[0007] Invention according to claim 3 is vacuum insulation material according to claim 1 or 2 to which thickness of said inorganic substance film is characterized by 5nm or more being 500nm or less.

[0008] In the vacuum insulation material which invention according to claim 4 enclosed heat insulation core material with the interior of the sheathing object which consists of a laminated film of two sheets which has gas barrier property, and carried out evacuation of the interior of a sheathing object, it is the vacuum insulation

material to which at least one in said laminated film is characterized by including the cascade screen of the organic substance film and inorganic substance film which were formed on the support base material.

[0009] Invention according to claim 5 is vacuum insulation material given in either of claims 4 to which one sheet located in an elevated temperature side among said laminated films is characterized by including the ingredient of thermal reflection.

[0010]

[Embodiment of the Invention] Hereafter, the gestalt of 1 operation of this invention is explained to a detail using drawing. The heat insulation core material 5 is enclosed with the interior of the sheathing object 1 containing the laminated film which has gas barrier property, evacuation of the interior of a sheathing object is carried out, and the vacuum insulation material of this invention is characterized by including the cascade screen of said laminated film, the organic substance film 7, and the inorganic substance film 8, the laminated films 2 and 3 with which the vacuum insulation material of this invention has gas barrier property — since — from the becoming sheathing object — becoming — the last — the method seal of four — carrying out — the laminated film 4 good also as vacuum insulation material which carries out (drawing 1) and has the gas barrier property of one sheet — since — it consists of a becoming sheathing object, and the method seal of three is carried out to the last, and good (drawing 2) also as vacuum insulation material.

[0011] The laminated film containing the cascade screen of the organic substance film of this invention and the inorganic substance film forms the cascade screen of the organic substance film and the inorganic substance film on a support base material at least. As a support base material, polyethylene terephthalate (PET), polyethylenenaphthalate (PEN), Polyester, such as polybutylene terephthalate (PBT), polyethylene (PE), Polyolefines, such as polypropylene (PP) and polystyrene (PS), Polyamides (PA), such as nylon 6 and Nylon 66, polyimide, Polyacrylate, a polyvinyl elochol (PVC), a polyvinylidene chloride (PVDC), it is no extending or the oriented film of polyvinyl alcohol (PVA), an ethylene-vinylalcohol copolymer (EVOH), a polycarbonate (PC), polyether sulfone (PES), polymethylmethacrylates (PMMA), etc. and these copolymers. In advance of formation of the cascade screen of the organic substance film and the inorganic substance film, the front face of these support base materials does not interfere, even if surface treatment, such as corona treatment, flame treatment, low-temperature plasma treatment, and a chemical treatment, is performed. Moreover, additives, such as an antistatic agent, an ultraviolet ray absorbent, a plasticizer, and lubricant, may be contained in these plastic film if needed.

[0012] As inorganic substance film in this invention, metal aluminum (aluminum), an aluminum oxide (AlOx), Oxidation silicon (SiOx), a magnesium oxide (MgO), a calcium oxide (CaO), Titanium oxide (TiO2), a zirconium dioxide (ZrO2), aluminium nitride (AlN), Titanium nitride (TiN), silicon nitride (Si3N4), acid aluminium nitride (AlOxNy), The independent film of inorganic substances, such as acid silicon nitride (SiOxNy), acid titanium nitride (TiOxNy), an indium stannic acid ghost (ITO), and indium cerium oxide (ICO), or the mixture film and cascade screen of two or more inorganic substances are used. Such inorganic substance film is formed of vacuum processes, such as a vacuum deposition method, the sputtering method, and chemical vapor deposition (CVD method). Moreover, although the thickness changes a little with classes of inorganic substance film, it is important that they are 5nm or more and 500nm or less. The inorganic substance prepared on the support base material as it is 5nm or less may become island shape, and may not become film-like, and when it is 500nm or more, it is because the film may break or it may separate from a support base material with own internal stress of film. Moreover, since a heat bridge may become large and heat insulation property may fall when the inorganic substance film is aluminum, it is important that it is especially 500nm or less. Moreover, if it is extent which checks neither gas barrier property ability nor heat insulation property, even if other components are contained in such inorganic substance film, it will not interfere.

[0013] If the organic substance film in this invention is prepared for the purpose of making smooth irregularity of a support base material front face, intercepting the crack of the inorganic substance film, and propagation of a defect, easing the internal stress in the inorganic substance film, protecting the inorganic substance film, etc. and accompanies these purposes, especially neither, such as the component, a presentation and thickness, and the formation approach, will be limited. However, since the speed of a polymerization cure rate and aging after coating are unnecessary, it is desirable to stiffen the resin of ultraviolet rays or electron ray polymerization nature with ultraviolet rays or an electron ray.

[0014] Specifically Isoamyl acrylate, laurylacrylate, stearylacrylate, Butoxy ethyl acrylate, ethoxy diethylene—glycol acrylate, Methoxy triethylene glycol acrylate, methoxy polyethylene—glycol acrylate, Methoxy dipropylene glycol acrylate, phenoxy ethyl acrylate, Phenoxy polyethylene—glycol acrylate, phenol EO denaturation acrylate, Nonyl phenol EO denaturation acrylate, tetrahydrofurfuryl acrylate, ISOBO nil acrylate, 2—hydroxyethyl acrylate, 2—hydroxyethyl acrylate, 2—hydroxyethyl acrylate, 2—hydroxyethyl acrylate, 2—hydroxyethyl acrylate, 2—AKURIRO yloxy ethyl succinic acid, 2—AKURIRO yloxy ethyl phthalic acid, Monofunctional

acrylate, such as 2-ethylhexyl carbitol acrylate and an N-vinyl-2-pyrrolidone, Methyl methacrylate, ethyl methacrylate, n-butyl methacrylate, Isobutyl methacrylate, 2-ethylhexyl methacrylate, isodecyl methacrylate, nlauryl methacrylate, alkyl methacrylate, tridecyl methacrylate, n-stearyl methacrylate, methoxy ethylene glycol ∍methacrylate, Methoxy połyethylene−glycol methacrylate, cyclohexyl methacrylate, Tetrahydrofurfuryl methacrylate, benzyl methacrylate, Phenoxy ethyl methacrylate, ISOBO nil methacrylate, 2-hydroxyethyl methacrylate, 2-hydroxypropyl methacrylate, 2-hydroxy butyl methacrylate, Dimethylaminoethyl methacrylate. diethylamino ethyl methacrylate, A methacrylic acid, 2-METAKURIRO yloxy ethyl succinic acid, 2-meta-KURIRO yloxy ethylhexahydrophthalic acid, 2-meta-KURIRO yloxy ethyl-2-hydroxypropyl phthalate, Monofunctional methacrylate, such as glycidyl methacrylate, triethylene glycol diacrylate, Polyethylene-glycol diacrylate, neopentyl glycol diacrylate. 1.6-hexanediol diacrylate, 1.9-nonane diol diacrylate. Dimethylol tricyclodecane diacrylate, ethylene glycol dimethacrylate, Diethylene-glycol dimethacrylate, 1.4-butanediol dimethacrylate, 1.6hexanedioldimethacrylate, 1.9-nonane diol dimethacrylate, Acrylate and methacrylate of two organic functions, such as glycerol dimethacrylate and 2-hydroxy-3-AKURIRO yloxy propyl methacrylate, Trimethylolpropane triacrylate, pentaerythritol thoria KURIRE-TO, Pentaerythritol tetraacrylate, dipentaerythritol hexaacrylate, Trimethylolpropanetrimethacrylate, pentaerythritol thoria KURIRE-TOHEKISA methylene di-isocyanate, Pentaerythritol thoria KURIRE-TOTORI range isocyanate, Pentaerythritol thoria KURIRE-TOISO holon diisocyanate, Dipentaerythritol hexaacrylate, a dipentaerythritol hexaacrylate caprolactone addition product, Although acrylate, methacrylate, etc. of three or more organic functions, such as a sorbitol hexa acrylate ethyleneoxide (EO) addition product, are mentioned, it is not limited to these.

[0015] Moreover, these acrylate and methacrylate may be used independently, and two or more may be mixed and used. Especially in the case of monofunctional acrylate or methacrylate, it mixes with the acrylate of two or more organic functions, or methacrylate, and is used. Moreover, an organic compound without other ultraviolet—rays hardenability and electron ray hardenability may be mixed, and you may use.

[0016] since such organic substance film carries out polymerization hardening by irradiating ultraviolet rays and an electron ray, it is possible also for the membrane formation in a vacuum whose membrane formation rate does not need after treatment, such as quick aging, and in-line-izing with the vacuum process for mixing of an impurity being avoided upwards and forming an inorganic substance is possible for it — etc. — it has the outstanding description. Moreover, although the thickness changes with the class of organic substance, the coating approaches, hardening means, etc., about 0.2-5.0 micrometers is suitable in general. When thinner than 0.2 micrometers, it is because the organic substance film may not turn into continuation film, and when thicker than 5.0 micrometers, it is because stress starts the inorganic substance film and the fall of barrier property may be seen by hardening contraction of the organic substance film.

[0017] After melting the desired organic substance and its mixture to a solvent and coating with approaches, such as gravure coating, as the membrane formation approach of such organic substance film, it is also one approach to volatilize a solvent in oven etc., to irradiate ultraviolet rays and an electron ray subsequently, and to carry out polymerization hardening. Moreover, it can be said that it is the approach for which it was most suitable from irradiating ultraviolet rays after making it condense as liquid membrane on the base material which the desired organic substance and its mixture were evaporated in the vacuum, and was cooled, and an electron ray, carrying out polymerization hardening, and moreover the organic substance film of the desired presentation of a flash evaporation method as the evaporation—in vacuum approach being easily obtained in this case at high speed.

[0018] Moreover, especially a limit may not be in the built-up sequence or the number of layers of said organic substance film and inorganic substance film, two or more organic substance film and inorganic substance film may be the same, and it may be another. Moreover, the laminating of the stratum functionale of further others is carried out besides the organic substance film and the inorganic substance film, and it is good also as a laminated film. For example, in order to thrust and to raise reinforcement, the laminating of the nylon etc. can be carried out.

[0019] The number of the laminated films which have said gas barrier property which carries out a sheathing object configuration in this invention may be two, and it is desirable that the laminated film by the side of an elevated temperature contains the ingredient of thermal reflection in that case, and it is desirable that the laminated film by the side of low temperature contains the cascade screen of said organic substance film and inorganic substance film. As a thermal reflex ingredient, a metallic foil etc. is mentioned, for example. If it does in this way, the heat from an elevated temperature side is reflected and conduction of the heat by the side of low temperature can be reduced.

[0020] Furthermore, it comes to carry out the laminating of the sealant layer 9 to which laminated films 2, 3, and 4 become the outermost layer from the resin which has heat—sealing nature, such as polyethylene, polypropylene, and an ethylene copolymer. The laminating of such a sealant layer is carried out by laminating the

film-ized ingredient through adhesives (not shown), or extruding the fused resin directly.

[0021] Moreover, in order to use as vacuum insulation material of this invention, it is desirable as gas barrier property of said laminated films 2, 3, and 4 in oxygen transmittance and steam transmittance being 0.5 (cm3/m2, day) and below 0.1 (g/m2, day), respectively, and it is still more desirable in it being 0.1 (cm3/m2, day) and below 0.05 (g/m2, day).

[0022] The vacuum insulation material of this invention can be obtained by filling up with and vacuum-packing the adiathermic core material 4 by making into an inside the heat-sealing nature resin layer of a layered product which consists of such a configuration. The Plastic solid with which these adiathermic core materials fabricated powder, such as a silica, and a pearlite, a calcium silicate, in the fixed configuration is used.
[0023]

[Example] Next, one concrete example is given and the vacuum insulation material of this invention is explained in more detail.

[0024] The PET film [lumiler P60 Toray Industries make] with a <example 1> thickness of 12 micrometers was used as the base material 5, it coated with the acrylate monomer [triethylene glycol diacrylate] (henceforth, Ac1) so that the thickness after drying on the one side might be set to about 1 micrometer, and the organic substance film 7 was formed by irradiating the electron ray of the acceleration voltage of 120kV, and quantity—of—radiation 10Mrad, and stiffening it. Then, after having used electron ray heating type rolling—up vacuum evaporationo equipment on this organic substance film 7, forming exidation silicon (henceforth, SiOx) with a thickness of about 40nm and considering as the inorganic substance film 8, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on the inorganic substance film 8, it considered as the sealant layer 9, and the laminated film 4 of this invention was obtained. Subsequently, facing each other and the circumference were heat sealed for sealant layer 9 comrades of this laminated film, vacuum seal of the Plastic solid of a powder silica was carried out as heat insulation core material 5, and the vacuum insulation material shown in drawing 1 was obtained. The thermal conductivity measured in the gas barrier property [the oxygen transmission rate and the steam transmission rate] and this vacuum insulation material center section of the sheathing object of this vacuum insulation material was shown in Table 1.

[0025] Except having prepared the <example 2> organic substance film and the inorganic substance film like Ac1/SiOx/Ac1/SiOx/Ac1 sequentially from the base material side by the same thickness as an example 1, and the approach, it is the same approach as an example 1, and the laminated film 4 of this invention was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this laminated film, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0026] The PET film [lumiler P60 Toray Industries make] with a <example 3> thickness of 12 micrometers was used as the base material 5, it coated with the acrylate monomer [tripropylene glycol diacrylate] (henceforth, Ac2) containing 5% of the weight of a photopolymerization initiator [the product made from IRGACURE 184 tiba SUPESHARUTI KEMIKARUZU] so that the thickness after drying on the one side might be set to about 1 micrometer, and the organic substance film 7 was formed by irradiating the ultraviolet rays of 120 mJ/cm2 and stiffening them. Then, after using electron ray heating type rolling—up vacuum evaporationo equipment as inorganic substance film 8 and forming metal aluminum (henceforth, aluminum) with a thickness of about 40nm on this organic substance film 7, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on the metal aluminum film, it considered as the sealant layer 9, and the laminated film 4 of this invention was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this laminated film, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0027] Except having prepared the <example 4> organic substance film and the inorganic substance film like Ac2/aluminum/Ac2/aluminum/Ac2 sequentially from the base material side by the same thickness as an example 3, and the approach, it is the same approach as an example 3, and the laminated film 4 of this invention was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this laminated film, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0028] The PET film [lumiler P60 Toray Industries make] with a <example 5> thickness of 12 micrometers was used as the base material \$, it costed with the sorylate monomer [pentagrythritel theris KURIRE-TOHEKISA]

methylene di-isocyanate] (henceforth, Ac3) so that the thickness after drying on the one side might be set to about 1 micrometer, and the organic substance film 7 was formed by irradiating the electron ray of the acceleration voltage of 120kV, and quantity—of—radiation 10Mrad, and stiffening it. Then after using the direct—current magnetron type rolling—up sputtering system as inorganic substance film 8 and forming an indium cerium oxide (henceforth, ICO) with a thickness of about 50nm on this organic substance film 7, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on this oxide film, it considered as the sealant layer 9, and the laminated film 4 of this invention was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this laminated film, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0029] Except having prepared the <example 6> organic substance film and the inorganic substance film like Ac3/ICO/Ac3/ICO/Ac3 sequentially from the base material side by the same thickness as an example 5, and the approach, it is the same approach as an example 5, and the laminated film 4 of this invention was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this laminated film, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0030] The PET film [lumiler P60 Toray Industries make] with a <example 7> thickness of 12 micrometers was used as the base material, on the one side, by the same approach as an example 3, the vacuum evaporationo layer of metal aluminum (aluminum) with a thickness of about 40nm was prepared, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on it, it considered as the sealant layer, and the laminated film 2 by the side of an elevated temperature was obtained. Except having prepared the organic substance film and the inorganic substance film like Ac1/SiOx/Ac1/SiOx/Ac1 sequentially from the base material side by the same thickness as an example 1, and the approach By the same approach as an example 1, the vacuum insulation material which obtained the laminated film 3 by the side of the low temperature of this invention and which ranks second, heat seals facing each other and the circumference for sealant layer 9 comrades of these laminated films 2 and 3, carries out vacuum seal of the Plastic solid of a powder silica as heat insulation core material 5, and is shown in drawing 2 was obtained. The thermal conductivity measured in the gas barrier property [the oxygen transmission rate and the steam transmission rate] and this vacuum insulation material center section of the sheathing object of this vacuum insulation material was shown in Table 1.

[0031] The PET film [lumiler P60 Toray Industries make] with a <example 1 of comparison> thickness of 12 micrometers was used as the base material, on the one side, by the same approach as an example 1, the oxidation silicon layer (SiOx) with a thickness of about 40nm was prepared, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on it, it considered as the sealant layer, and the layered product was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this layered product, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0032] The PET film [lumiler P60 Toray Industries make] with a <example 2 of comparison> thickness of 12 micrometers was used as the base material, on the one side, by the same approach as an example 3, the vacuum evaporationo layer of metal aluminum (aluminum) with a thickness of about 40nm was prepared, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on it, it considered as the sealant layer, and the layered product was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this layered product, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0033] The PET film [lumiler P60 Toray Industries make] with a <example 3 of comparison> thickness of 12 micrometers was used as the base material, on the one side, by the same approach as an example 5, about 50nm indium cerium oxide layer (ICO) was prepared, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on it, it considered as the sealant layer, and the layered product was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this layered product, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica

were measured like the example 1. The measurement result was shown in Table 1.

-[0034] The PET film [lumiler P60 Toray Industries make] with a <example 4 of comparison> thickness of 12 micrometers was used as the base material, and it coated with the acrylate monomer [triethylene glycol diacrylate] (Ac1) so that the thickness after desiccation might be set to about 1 micrometer at the one side, and the polymer layer was formed by irradiating the electron ray of the acceleration voltage of 120kV, and quantity—of—radiation 10Mrad, and stiffening it. The low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on the acrylate layer, it considered as the sealant layer, and the layered product was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this layered product, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0035] The PET film [lumiler P60 Toray Industries make] with a <example 5 of comparison> thickness of 12 micrometers was used as the base material, and it coated with the acrylate monomer [tripropylene glycol diacrylate] (Ac2) containing 5% of the weight of a photopolymerization initiator [the product made from IRGACURE 184 tiba SUPESHARUTI KEMIKARUZU] so that the thickness after desiccation might be set to about 1 micrometer at the one side, and the polymer layer was formed by irradiating the ultraviolet rays of 120 mJ/cm2 and stiffening them. Then, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on this acrylate layer, it considered as the sealant layer, and the layered product was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this layered product, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0036] The PET film [lumiler P60 Toray Industries make] with a <example 6 of comparison> thickness of 12 micrometers was used as the base material, and it coated with the acrylate monomer [pentaerythritol thoria KURIRE-TOHEKISA methylene di-isocyanate] (Ac3) so that the thickness after desiccation might be set to about 1 micrometer at the one side, and the polymer layer was formed by irradiating the electron ray of the acceleration voltage of 120kV, and quantity-of-radiation 10Mrad, and stiffening it. Then, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on this acrylate layer, it considered as the sealant layer, and the layered product was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this layered product, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0037] The PET film [lumiler P60 Toray Industries make] with a <example 7 of comparison> thickness of 12 micrometers was used as the base material, through polyester polyurethane system adhesives (not shown), metal aluminium foil with a thickness of 7 micrometers was laminated on that one side, it was followed, on this metal aluminium foil, the low consistency polyethylene film with a thickness of 60 micrometers was laminated using the same adhesives, it considered as the sealant layer, and the layered product was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this layered product, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0038] [Table 1]

	HARACATE III I	ガスノリアを		
	外数体中の数据フィル人の 有機物域、無機物域の無機成	(appl /m day)	水黄素	(M/m·K)
3831	Act / SiOx	6.8	0.07	0.000
*E#2	Ac 1/8/0x/Ac 1/8/0x/Ac 1	0.03	0.00	0.000
表面例3	Ao 2/AJ	6.06	0.06	0.000
BEE 4	Ag 2/Al/Ag 2/Al/Ag 2	5001	SQ41	0.004
3 6 6	As 3/100	≦ 0.01	26.51	0.000
完集例6	An 3/100/An 3/100/An 3	≤9.01	S0.01	0.005
实施例7	高速機:Ac 1/80x/Ac 1/80x/Ac 1	0.5	0.8	0.005
12 1.11	elO _{IC}	2.5		0.010
比胜例2	Al	0.5	0.8	0.000
建键例3	100		2	0.056
正是月4	Ao 1	140	52	0.000
上数约5	Ac 2	140	62	0.600
比較例	Ac 3	140	62	0.000
22.17	Ai	34.1	34 1	

[0039] As shown in examples 1-7, in order to continue at a long period of time and to maintain the interior of

vacuum insulation material at a high degree of vacuum by using the laminated film which has the gas barrier property containing the cascade screen of the organic substance film and the inorganic substance film on a support base material as a sheathing object of vacuum insulation material, the sheathing object which has indispensable high gas barrier property was acquired, and there is no heat conduction by the heat bridge, and the vacuum insulation material which has high heat insulation property was obtained. Moreover, although the result shown in the examples 1–3 of a comparison and the examples 4–6 of a comparison was a thing at the time of using only the inorganic substance film and the organic substance film as a laminated film, respectively, with these sheathing objects, the gas barrier property as a case of an example was not obtained. Since the organic substance film had hardly contributed to improvement in gas barrier property especially in the case of the examples 4–6 of a comparison, the degree of vacuum inside vacuum insulation material was low from the start, and early thermal conductivity was [/ else] also high. Moreover, although sufficient gas barrier property was obtained even if this sheathing object compared with the thing of an example, although the result shown in the example 7 of a comparison was a thing at the time of using metal aluminium foil as gas barrier property, in the vacuum insulation material using this sheathing object, high heat insulation property was not obtained by heat conduction by the heat bridge.

[0040]

[Effect of the Invention] In the vacuum insulation material to which heat insulation core material was enclosed with the sheathing inside of the body which consists of a laminated film which has gas barrier property according to this invention as stated above, and evacuation of the interior of a sheathing object was carried out When said laminated film contains the cascade screen of the organic substance film and inorganic substance film which were formed on the support base material. The gas barrier property of a sheathing object is high, it continues at a long period of time, the vacua inside a sheathing object is maintained [there is no migration of the heat which lets the sheathing object of vacuum insulation material pass sufficient heat insulation property is obtained, and], and the vacuum insulation material by which heat insulation property is maintained can be offered.

[0041]

JP.2003-172493.A	TECHNICAL	FIELD]
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TECHNICAL FIELD

[Field of the Invention] This invention is attached in a refrigerator, a low-temperature container, etc., and relates to the vacuum insulation material which demonstrates adiabatic efficiency.

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PRIOR ART

[Description of the Prior Art] Various heat insulators are used from the former, as a heat insulator which was excellent in heat insulation property especially, adiathermic core material is enclosed with the sheathing inside of the body, and the vacuum insulation material of a configuration of having carried out evacuation of the interior is used for the refrigerator or the low-temperature container. This sheathing object needs to be excellent in gas barrier property, in order to prevent invasion of the gas (air) from the outside and to hold the interior to a vacua for a long period of time. Then, in order to give high gas barrier property conventionally, the laminated film which contains metal aluminium foil with a thickness of about 7–15 micrometers as that of the gas barrier layer of a sheathing object has mainly been used.

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EFFECT OF THE INVENTION

[Effect of the Invention] In the vacuum insulation material to which heat insulation core material was enclosed with the sheathing inside of the body which consists of a laminated film which has gas barrier property according to this invention as stated above, and evacuation of the interior of a sheathing object was carried out When said laminated film contains the cascade screen of the organic substance film and inorganic substance film which were formed on the support base material. The gas barrier property of a sheathing object is high, it continues at a long period of time, the vacua inside a sheathing object is maintained [there is no migration of the heat which lets the sheathing object of vacuum insulation material pass sufficient heat insulation property is obtained, and], and the vacuum insulation material by which heat insulation property is maintained can be offered.

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TECHNICAL PROBLEM

[Problem(s) to be Solved by the Invention] However, in the case of such aluminum foil, it excelled in gas barrier property, but since the heat conductivity of aluminum itself was high, there was a problem that sufficient heat insulation property was not obtained by heat conduction [a heat bridge] which lets a sheathing object pass. The approach [JP,8-159376,A] of using a stainless steel foil with comparatively small thermal conductivity etc. for the gas barrier layer of a sheathing object for the purpose of solution of this problem, the approach using the vacuum evaporationo film of aluminum, the ceramics, the approach [JP,7-113493,A and JP,8-152258,A] using the vacuum evaporationo film of glass, etc. are invented.

[0004] However, since the still in addition stainless heat conductivity is high, the approach using a stainless steel foil etc. of reduction of a heat bridge is inadequate. Moreover, although the approach using aluminum, the ceramics, or the vacuum evaporationo film of glass could be enough for reduction of a heat bridge, since a pinhole and a crack existed in the vacuum evaporationo film, gas barrier property was inadequate, and it was impossible to have continued at a long period of time and to have maintained the interior of a sheathing object at a vacua. It is offering the vacuum insulation material by which the gas barrier property of a sheathing object is [material] high, it continues at a long period of time, the vacua inside a sheathing object is maintained [this invention was made in view of such a situation, the place made into the purpose does not have migration of the heat which lets the sheathing object of vacuum insulation material pass, sufficient heat insulation property is obtained, and], and heat insulation property's is maintained.

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MEANS

[The means for solving invention] In the vacuum insulation material which invention according to claim 1 enclosed heat insulation core material with the interior of the sheathing object which consists of a laminated film which has gas barrier property, and carried out evacuation of the interior of a sheathing object, it is the vacuum insulation material to which said laminated film is characterized by including the cascade screen of the organic substance film and inorganic substance film which were formed on the support base material.

[0006] It is the vacuum insulation material according to claim 1 to which invention according to claim 2 is characterized by said organic substance film carrying out polymerization hardening of an electron ray or the ultraviolet—rays polymerization nature resin by the electron ray or ultraviolet rays.

[0007] Invention according to claim 3 is vacuum insulation material according to claim 1 or 2 to which thickness of said inorganic substance film is characterized by 5nm or more being 500nm or less.

[0008] In the vacuum insulation material which invention according to claim 4 enclosed heat insulation core material with the interior of the sheathing object which consists of a laminated film of two sheets which has gas barrier property, and carried out evacuation of the interior of a sheathing object, it is the vacuum insulation material to which at least one in said laminated film is characterized by including the cascade screen of the organic substance film and inorganic substance film which were formed on the support base material.

[0009] Invention according to claim 5 is vacuum insulation material given in either of claims 4 to which one sheet

[0009] Invention according to claim 5 is vacuum insulation material given in either of claims 4 to which one sheet located in an elevated temperature side among said laminated films is characterized by including the ingredient of thermal reflection.

[0010]

[Embodiment of the Invention] Hereafter, the gestalt of 1 operation of this invention is explained to a detail using drawing. The heat insulation core material 5 is enclosed with the interior of the sheathing object 1 containing the laminated film which has gas barrier property, evacuation of the interior of a sheathing object is carried out, and the vacuum insulation material of this invention is characterized by including the cascade screen of said laminated film, the organic substance film 7, and the inorganic substance film 8, the laminated films 2 and 3 with which the vacuum insulation material of this invention has gas barrier property — since sheathing object — becoming — the last — the method seal of four — carrying out — the laminated film 4 good also as vacuum insulation material which carries out (drawing 1) and has the gas barrier property of one sheet — since — it consists of a becoming sheathing object, and the method seal of three is carried out to the last, and good (drawing 2) also as vacuum insulation material.

[0011] The laminated film containing the cascade screen of the organic substance film of this invention and the inorganic substance film forms the cascade screen of the organic substance film and the inorganic substance film on a support base material at least. As a support base material, polyethylene terephthalate (PET), polyethylenenaphthalate (PEN), Polyester, such as polybutylene terephthalate (PBT), polyethylene (PE), Polyolefines, such as polypropylene (PP) and polystyrene (PS), Polyamides (PA), such as nylon 6 and Nylon 66, polyimide, Polyacrylate, a polyvinyl chloride (PVC), a polyvinylidene chloride (PVDC), it is no extending or the oriented film of polyvinyl alcohol (PVA), an ethylene-vinylalcohol copolymer (EVOH), a polycarbonate (PC), polyether sulfone (PES), polymethylmethacrylates (PMMA), etc. and these copolymers. In advance of formation of the cascade screen of the organic substance film and the inorganic substance film, the front face of these support base materials does not interfere, even if surface treatment, such as corona treatment, flame treatment, low-temperature plasma treatment, and a chemical treatment, is performed. Moreover, additives, such as an antistatic agent, an ultraviolet ray absorbent, a plasticizer, and lubricant, may be contained in these plastic film if needed.

[0012] As inorganic substance film in this invention, metal aluminum (aluminum), an aluminum oxide (AlOx), Oxidation silicon (SiOx), a magnesium oxide (MgO), a calcium oxide (CaO), Titanium oxide (TiO2), a zirconium dioxide (ZrO2), alumimium nitride (AlN), Titanium nitride (TiN), ailicon nitride (Si3N4), acid alumimium nitride

(AlOxNy), The independent film of inorganic substances, such as acid silicon nitride (SiOxNy), acid titanium nitride (TiOxNy), an indium stannic acid ghost (ITO), and indium cerium oxide (ICO), or the mixture film and cascade screen of two or more inorganic substances are used. Such inorganic substance film is formed of vacuum processes, such as a vacuum deposition method, the sputtering method, and chemical vapor deposition (CVD method). Moreover, although the thickness changes a little with classes of inorganic substance film, it is important that they are 5nm or more and 500nm or less. The inorganic substance prepared on the support base material as it is 5nm or less may become island shape, and may not become film-like, and when it is 500nm or more, it is because the film may break or it may separate from a support base material with own internal stress of film. Moreover, since a heat bridge may become large and heat insulation property may fall when the inorganic substance film is aluminum, it is important that it is especially 500nm or less. Moreover, if it is extent which checks neither gas barrier property ability nor heat insulation property, even if other components are contained in such inorganic substance film, it will not interfere.

[0013] If the organic substance film in this invention is prepared for the purpose of making smooth irregularity of a support base material front face, intercepting the crack of the inorganic substance film, and propagation of a defect, easing the internal stress in the inorganic substance film, protecting the inorganic substance film, etc. and accompanies these purposes, especially neither, such as the component, a presentation and thickness, and the formation approach, will be limited. However, since the speed of a polymerization cure rate and aging after coating are unnecessary, it is desirable to stiffen the resin of ultraviolet rays or electron ray polymerization nature with ultraviolet rays or an electron ray.

[0014] Specifically Isoamyl acrylate, laurylacrylate, stearylacrylate, Butoxy ethyl acrylate, ethoxy diethyleneglycol acrylate, Methoxy triethylene glycol acrylate, methoxy polyethylene-glycol acrylate, Methoxy dipropylene glycol acrylate, phenoxy ethyl acrylate, Phenoxy polyethylene-glycol acrylate, phenol EO denaturation acrylate, Nonyl phenol EO denaturation acrylate, tetrahydrofurfuryl acrylate, ISOBO nil acrylate, 2-hydroxyethyl acrylate, 2-hydroxypropyl acrylate, 2-hydroxy-3-phenoxypropylacrylate, 2-AKURIRO yloxy ethyl succinic acid, 2-AKURIRO yloxy ethyl phthalic acid, a 2-AKURIRO yloxy ethyl-2-hydroxyethyl phthalic acid, Monofunctional acrylate, such as 2-ethylhexyl carbitol acrylate and an N-vinyl-2-pyrrolidone, Methyl methacrylate, ethyl methacrylate, n-butyl methacrylate, Isobutyl methacrylate, 2-ethylhexyl methacrylate, isodecyl methacrylate, nlauryl methacrylate, alkyl methacrylate, tridecyl methacrylate, n-stearyl methacrylate, methoxy ethylene glycol methacrylate, Methoxy polyethylene-glycol methacrylate, cyclohexyl methacrylate, Tetrahydrofurfuryl methacrylate, benzyl methacrylate, Phenoxy ethyl methacrylate, ISOBO nil methacrylate, 2-hydroxyethyl methacrylate, 2-hydroxypropyl methacrylate, 2-hydroxy butyl methacrylate, Dimethylaminoethyl methacrylate, diethylamino ethyl methacrylate, A methacrylic acid, 2-METAKURIRO yloxy ethyl succinic acid, 2-meta-KURIRO yloxy ethylhexahydrophthalic acid, 2-meta-KURIRO yloxy ethyl-2-hydroxypropyl phthalate, Monofunctional methacrylate, such as glycidyl methacrylate, triethylene glycol diacrylate, Polyethylene†glycol diacrylate, neopentyl glycol diacrylate, 1.6-hexanediol diacrylate, 1.9-nonane diol diacrylate, Dimethylol tricyclodecane diacrylate, ethylene glycol dimethacrylate, Diethylene-glycol dimethacrylate, 1.4-butanediol dimethacrylate, 1.6hexanedioldimethacrylate, 1.9-nonane diol dimethacrylate, Acrylate and methacrylate of two organic functions, such as glycerol dimethacrylate and 2-hydroxy-3-AKURIRO yloxy propyl methacrylate, Trimethylolpropane triacrylate, pentaerythritol thoria KURIRE-TO, Pentaerythritol tetraecrylate, dipentaerythritol hexaecrylate, Trimethylolpropanetrimethacrylate, pentaerythritol thoria KURIRE-TOHEKISA methylene di-isocyanate, Pentaerythritol thoria KURIRE-TOTORI range isocyanate, Pentaerythritol thoria KURIRE-TOISO holon diisocyanate, Dipentaerythritol hexascrylate, a dipentaerythritol hexascrylate caprolactone addition product. Although acrylate, methacrylate, etc. of three or more organic functions, such as a sorbitol hexa acrylate ethyleneoxide (EO) addition product, are mentioned, it is not limited to these.

[0015] Moreover, these acrylate and methacrylate may be used independently, and two or more may be mixed and used. Especially in the case of monofunctional acrylate or methacrylate, it mixes with the acrylate of two or more organic functions, or methacrylate, and is used. Moreover, an organic compound without other ultravioletrays hardenability and electron ray hardenability may be mixed, and you may use.

[0016] since such organic substance film carries out polymerization hardening by irradiating ultraviolet rays and an electron ray, it is possible also for the membrane formation in a vacuum whose membrane formation rate does not need after treatment, such as quick aging, and in-line-izing with the vacuum process for mixing of an impurity being avoided upwards and forming an inorganic substance is possible for it — etc. — it has the outstanding description. Moreover, although the thickness changes with the class of organic substance, the coating approaches, hardening means, etc., about 0.2–5.0 micrometers is suitable in general. When thinner than 0.2 micrometers, it is because the organic substance film may not turn into continuation film, and when thicker than 5.0 micrometers, it is because stress starts the inorganic substance film and the fall of barrier property may be seen by hardening contraction of the organic substance film.

[0017] After melting the desired organic substance and its mixture to a solvent and coating with approaches, such as gravure coating, as the membrane formation approach of such organic substance film, it is also one approach to volatilize a solvent in oven etc., to irradiate ultraviolet rays and an electron ray subsequently, and to carry out polymerization hardening. Moreover, it can be said that it is the approach for which it was most suitable from irradiating ultraviolet rays after making it condense as liquid membrane on the base material which the desired organic substance and its mixture were evaporated in the vacuum, and was cooled, and an electron ray, carrying out polymerization hardening, and moreover the organic substance film of the desired presentation of a flash evaporation method as the evaporation—in vacuum approach being easily obtained in this case at high speed.

[0018] Moreover, especially a limit may not be in the built-up sequence or the number of layers of said organic substance film and inorganic substance film, two or more organic substance film and inorganic substance film may be the same, and it may be another. Moreover, the laminating of the stratum functionale of further others is carried out besides the organic substance film and the inorganic substance film, and it is good also as a laminated film. For example, in order to thrust and to raise reinforcement, the laminating of the nylon etc. can be carried out.

[0019] The number of the laminated films which have said gas barrier property which carries out a sheathing object configuration in this invention may be two, and it is desirable that the laminated film by the side of an elevated temperature contains the ingredient of thermal reflection in that case, and it is desirable that the laminated film by the side of low temperature contains the cascade screen of said organic substance film and inorganic substance film. As a thermal reflex ingredient, a metallic foil etc. is mentioned, for example. If it does in this way, the heat from an elevated temperature side is reflected and conduction of the heat by the side of low temperature can be reduced.

[0020] Furthermore, it comes to carry out the laminating of the sealant layer 9 to which laminated films 2, 3, and 4 become the outermost layer from the resin which has heat-sealing nature, such as polyethylene, polypropylene, and an ethylene copolymer. The laminating of such a sealant layer is carried out by laminating the

film-ized ingredient through adhesives (not shown), or extruding the fused resin directly.

[0021] Moreover, in order to use as vacuum insulation material of this invention, it is desirable as gas barrier property of said laminated films 2, 3, and 4 in oxygen transmittance and steam transmittance being 0.5 (cm3/m2, day) and below 0.1 (g/m2, day), respectively, and it is still more desirable in it being 0.1 (cm3/m2, day) and below 0.05 (g/m2, day).

[0022] The vacuum insulation material of this invention can be obtained by filling up with and vacuum-packing the adiathermic core material 4 by making into an inside the heat-sealing nature resin layer of a layered product which consists of such a configuration. The Plastic solid with which these adiathermic core materials fabricated powder, such as a silica, and a pearlite, a calcium silicate, in the fixed configuration is used.

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EXAMPLE

[Example] Next, one concrete example is given and the vacuum insulation material of this invention is explained in more detail.

[0024] The PET film [lumiler P60 Toray Industries make] with a <example 1> thickness of 12 micrometers was used as the base material 5, it coated with the acrylate monomer [triethylene glycol diacrylate] (henceforth, Ac1) so that the thickness after drying on the one side might be set to about 1 micrometer, and the organic substance film 7 was formed by irradiating the electron ray of the acceleration voltage of 120kV, and quantity—of—radiation 10Mrad, and stiffening it. Then, after having used electron ray heating type rolling—up vacuum evaporationo equipment on this organic substance film 7, forming oxidation silicon (henceforth, SiOx) with a thickness of about 40nm and considering as the inorganic substance film 8, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on the inorganic substance film 8, it considered as the sealant layer 9, and the laminated film 4 of this invention was obtained. Subsequently, facing each other and the circumference were heat sealed for sealant layer 9 comrades of this laminated film, vacuum seal of the Plastic solid of a powder silica was carried out as heat insulation core material 5, and the vacuum insulation material shown in drawing 1 was obtained. The thermal conductivity measured in the gas barrier property [the oxygen transmission rate and the steam transmission rate] and this vacuum insulation material center section of the sheathing object of this vacuum insulation material was shown in Table 1.

[0025] Except having prepared the <example 2> organic substance film and the inorganic substance film like Ac1/SiOx/Ac1/SiOx/Ac1 sequentially from the base material side by the same thickness as an example 1, and the approach, it is the same approach as an example 1, and the laminated film 4 of this invention was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this laminated film, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0026] The PET film [lumiler P60 Toray Industries make] with a <example 3> thickness of 12 micrometers was used as the base material 5, it coated with the acrylate monomer [tripropylene glycol diacrylate] (henceforth, Ac2) containing 5% of the weight of a photopolymerization initiator [the product made from IRGACURE 184 tiba SUPESHARUTI KEMIKARUZU] so that the thickness after drying on the one side might be set to about 1 micrometer, and the organic substance film 7 was formed by irradiating the ultraviolet rays of 120 mJ/cm2 and stiffening them. Then, after using electron ray heating type rolling—up vacuum evaporationo equipment as inorganic substance film 8 and forming metal aluminum (henceforth, aluminum) with a thickness of about 40nm on this organic substance film 7, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on the metal aluminum film, it considered as the sealant layer 9, and the laminated film 4 of this invention was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this laminated film, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0027] Except having prepared the <example 4> organic substance film and the inorganic substance film like Ac2/aluminum/Ac2/aluminum/Ac2 sequentially from the base material side by the same thickness as an example 3, and the approach, it is the same approach as an example 3, and the laminated film 4 of this invention was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this laminated film, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0028] The PET film [lumiler P60 Toray Industries make] with a <example 5> thickness of 12 micrometers was used as the base material 5, it coated with the acrylate monomer [pentaerythritol thoria KURIRE-TOHEKISA methylene di-isocyanate] (henceforth, Ac3) so that the thickness after drying on the one side might be set to about 1 micrometer, and the organic substance film 7 was formed by irradiating the electron ray of the acceleration voltage of 120kV, and quantity-of-radiation 10Mrad, and stiffening it. Then, after using the direct-current magnetron type rolling-up sputtering system as inorganic substance film 8 and forming an indium cerium oxide (henceforth, ICO) with a thickness of about 50nm on this organic substance film 7, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on this oxide film, it considered as the sealant layer 9, and the laminated film 4 of this invention was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this laminated film, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0029] Except having prepared the <example 6> organic substance film and the inorganic substance film like Ac3/ICO/Ac3/ICO/Ac3 sequentially from the base material side by the same thickness as an example 5, and the approach, it is the same approach as an example 5, and the laminated film 4 of this invention was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this laminated film, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0030] The PET film [lumiler P60 Toray Industries make] with a <example 7> thickness of 12 micrometers was used as the base material, on the one side, by the same approach as an example 3, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on it, it considered as the sealant layer, and the laminated film 2 by the side of an elevated temperature was obtained. Except having prepared the organic substance film and the inorganic substance film like Ac1/SiOx/Ac1/SiOx/Ac1 sequentially from the base material side by the same thickness as an example 1, and the approach By the same approach as an example 1, the vacuum insulation material which obtained the laminated film 3 by the side of the low temperature of this invention and which ranks second, heat seals facing each other and the circumference for sealant layer 9 comrades of these laminated films 2 and 3, carries out vacuum seal of the Plastic solid of a powder silica as heat insulation core material 5, and is shown in drawing 2 was obtained. The thermal conductivity measured in the gas barrier property [the oxygen transmission rate and the steam transmission rate] and this vacuum insulation material center section of the sheathing object of this vacuum insulation material was shown in Table 1.

[0031] The PET film [lumiler P60 Toray Industries make] with a <example 1 of comparison> thickness of 12 micrometers was used as the base material, on the one side, by the same approach as an example 1, the oxidation silicon layer (SiOx) with a thickness of about 40nm was prepared, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on it, it considered as the sealant layer, and the layered product was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this layered product, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0032] The PET film [lumiler P60 Toray Industries make] with a <example 2 of comparison> thickness of 12 micrometers was used as the base material, on the one side, by the same approach as an example 3, the vacuum evaporationo layer of metal aluminum (aluminum) with a thickness of about 40nm was prepared, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on it, it considered as the sealant layer, and the layered product was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this layered product, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0033] The PET film [lumiler P60 Toray Industries make] with a <example 3 of comparison> thickness of 12 micrometers was used as the base material, on the one side, by the same approach as an example 5, about 50nm indium cerium oxide layer (ICO) was prepared, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on it, it considered as the sealant layer, and the layered product was obtained. Facing each other and the circumference were heat

sealed for the sealant layers of this layered product, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0034] The PET film [lumiler P60 Toray Industries make] with a <example 4 of comparison> thickness of 12 micrometers was used as the base material, and it coated with the acrylate monomer [triethylene glycol diacrylate] (Ac1) so that the thickness after desiccation might be set to about 1 micrometer at the one side, and the polymer layer was formed by irradiating the electron ray of the acceleration voltage of 120kV, and quantity—of—radiation 10Mrad, and stiffening it. The low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on the acrylate layer, it considered as the sealant layer, and the layered product was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this layered product, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0035] The PET film [lumiler P60 Toray Industries make] with a <example 5 of comparison> thickness of 12 micrometers was used as the base material, and it coated with the acrylate monomer [tripropylene glycol diacrylate] (Ac2) containing 5% of the weight of a photopolymerization initiator [the product made from IRGACURE 184 tiba SUPESHARUTI KEMIKARUZU] so that the thickness after desiccation might be set to about 1 micrometer at the one side, and the polymer layer was formed by irradiating the ultraviolet rays of 120 mJ/cm2 and stiffening them. Then, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on this acrylate layer, it considered as the sealant layer, and the layered product was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this layered product, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0036] The PET film [lumiler P60 Toray Industries make] with a <example 6 of comparison> thickness of 12 micrometers was used as the base material, and it coated with the acrylate monomer [pentaerythritol thoria KURIRE-TOHEKISA methylene di-isocyanate] (Ac3) so that the thickness after desiccation might be set to about 1 micrometer at the one side, and the polymer layer was formed by irradiating the electron ray of the acceleration voltage of 120kV, and quantity-of-radiation 10Mrad, and stiffening it. Then, the low consistency polyethylene film with a thickness of 60 micrometers was laminated through polyester polyurethane system adhesives (not shown) on this acrylate layer, it considered as the sealant layer, and the layered product was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this layered product, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0037] The PET film [lumiler P60 Toray Industries make] with a <example 7 of comparison> thickness of 12 micrometers was used as the base material, through polyester polyurethane system adhesives (not shown), metal aluminium foil with a thickness of 7 micrometers was laminated on that one side, it was followed, on this metal aluminium foil, the low consistency polyethylene film with a thickness of 60 micrometers was laminated using the same adhesives, it considered as the sealant layer, and the layered product was obtained. Facing each other and the circumference were heat sealed for the sealant layers of this layered product, and the gas barrier property and the thermal conductivity of the vacuum insulation material which carried out vacuum seal and acquired the Plastic solid of a powder silica were measured like the example 1. The measurement result was shown in Table 1.

[0038]

[Table 1]

	unthhammer as to	ガスノリアを			
	外被体中の機関フィルムの 有機物能、無機物能の原領域	(ggn /m -day) (g/m -day)		(NF/NI-IC)	
	Act / SlOx Ac 1 / SlOx / Ac 1 / SlOx / Ac 1	9.03	0.07 0.02	0.585	
	Ac 2/Al/Ac 2/Al/Ac 2	≤0.01	0.56 ≤0.01	0.000	
東京第5 東京第6	As 3/100 As 3/100/As 8/100/As 8	≦8.81 ≤8.01	34.5 1	0.004	
完装例7	高重視:Ac 1/90x/Ac 1/90x/Ac 1	0.5	0.8	0.006	
比較例2 比較例2 比較例3	Al ICO	25 05 2	0.0 2	97.CL0 900.0 940.0	
注题[44 注题[45 注题[45	Ac 2 Ac 3	140	3 5 E		
2.17					

[0039] As shown in examples 1-7, in order to continue at a long period of time and to maintain the interior of vacuum insulation material at a high degree of vacuum by using the laminated film which has the gas barrier property containing the cascade screen of the organic substance film and the inorganic substance film on a support base material as a sheathing object of vacuum insulation material, the sheathing object which has indispensable high gas barrier property was acquired, and there is no heat conduction by the heat bridge, and the vacuum insulation material which has high heat insulation property was obtained. Moreover, although the result shown in the examples 1-3 of a comparison and the examples 4-6 of a comparison was a thing at the time of using only the inorganic substance film and the organic substance film as a laminated film, respectively, with these sheathing objects, the gas barrier property as a case of an example was not obtained. Since the organic substance film had hardly contributed to improvement in gas barrier property especially in the case of the examples 4-6 of a comparison, the degree of vacuum inside vacuum insulation material was low from the start, and early thermal conductivity was [/ else] also high. Moreover, although sufficient gas barrier property was obtained even if this sheathing object compared with the thing of an example, although the result shown in the example 7 of a comparison was a thing at the time of using metal aluminium foil as gas barrier property, in the vacuum insulation material using this sheathing object, high heat insulation property was not obtained by heat conduction by the heat bridge.

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DRAWINGS

